

Silicon NPN Power Transistors

2SD1427

DESCRIPTION

- With TO-3P(H)1S package
- Built-in damper diode
- High voltage ,high speed
- Low collector saturation voltage

APPLICATIONS

- Designed for use in large screen color deflection circuits

PINNING

PIN	DESCRIPTION
1	Base
2	Collector
3	Emitter

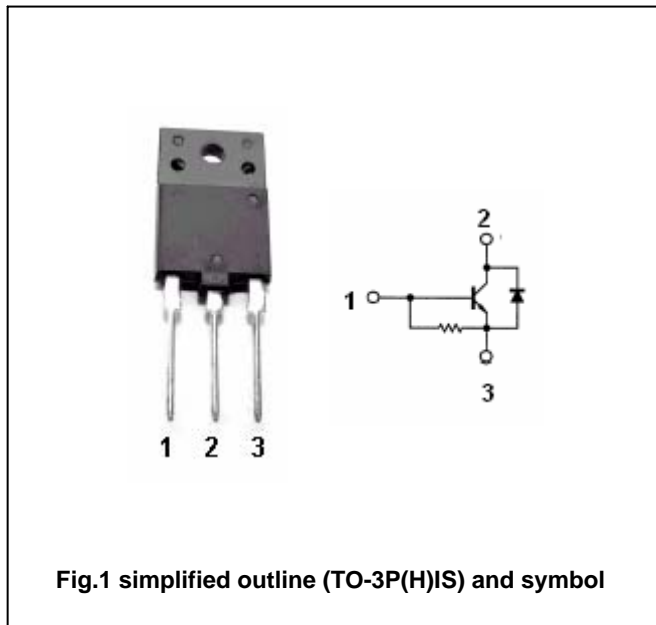


Fig.1 simplified outline (TO-3P(H)1S) and symbol

Absolute maximum ratings (T_a=25)

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V _{CBO}	Collector-base voltage	Open emitter	1500	V
V _{CEO}	Collector-emitter voltage	Open base	600	V
V _{EBO}	Emitter-base voltage	Open collector	5	V
I _C	Collector current		5	A
I _B	Base current		2.5	A
P _D	Total power dissipation	T _C =25	80	W
T _j	Junction temperature		150	
T _{stg}	Storage temperature		-55~150	

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	MAX	UNIT
R _{th j-c}	Thermal resistance junction case	1.56	/W

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CHARACTERISTICS

T_j=25 unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V _{(BR)EBO}	Emitter-base breakdown voltage	I _E =200mA; I _C =0	5			V
V _{CE(sat)}	Collector-emitter saturation voltage	I _C =4A; I _B =0.8A			5.0	V
V _{BE(sat)}	Base-emitter saturation voltage	I _C =4A; I _B =0.8A			1.5	V
I _{CBO}	Collector cut-off current	V _{CB} =500V; I _E =0			10	μA
h _{FE}	DC current gain	I _C =1A; V _{CE} =5V	8			
f _T	Transition frequency	I _C =0.1A; V _{CE} =10V; f=1MHz		3		MHz
C _{OB}	Output capacitance	I _E =0; V _{CB} =10V; f=1MHz		165		pF
V _F	Diode forward voltage	I _F =5A			2.0	V
t _f	Fall time	I _C =4A; I _{B1} =0.8A			1.0	μs

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PACKAGE OUTLINE

